

Application No. 09/852,709
Docket No. 03-10; 51985 (ACT-201)

Art Unit 2874
Examiner Michael J. Stahl

Amendments to the Specification

Please amend paragraph [0120] to read as follows. Support for the amendment can be found at least in the last sentence of sheet 3 of the provisional application from which priority was claimed and which was incorporated by reference into the subject application at the time of filing.

[0120] It should be further understood that the chip 32 may slide on mounting structures which are not integral with the base structure. As shown on FIG. 4, the chip 32 may be slidably mounted on a substrate 212. The substrate 212 differs from the substrate 12 and 112 in that it lacks integral rails, such as the rails 14 or 114, and instead has grooves 213. A fiber 214 is positioned in each groove 213, and the fibers 214 are held in place with an adhesive 215. Obviously, to prevent movement of the chip 22 (FIGS. 1-2), the chip 22 may be adhered to the fibers 214 or otherwise rendered immobile relative thereto. Alternatively, the fibers 214 may be bonded to the movable array 32 so that the movable array 32 moves by sliding the fibers 214 on the substrate 212.